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Abstract

The significant progress in terms of fabricating large-area graphene films for transparent electrodes, barriers, electronics, telecommunication and other applications has not yet been accompanied by efficient methods for characterizing the electrical properties of large-area graphene. While in the early prototyping as well as research and development phases, electrical test devices created by conventional lithography have provided adequate insights, this approach is becoming increasingly problematic due to complications such as irreversible damage to the original graphene film, contamination, and a high measurement effort per device. In this topical review, we provide a comprehensive overview of the issues that need to be addressed by any large-area characterisation method for electrical key performance indicators, with emphasis on electrical uniformity and on how this can be used to provide a more accurate analysis of the graphene film. We review and compare three different, but complementary approaches that rely either on fixed contacts (dry laser lithography), movable contacts (micro four point probes) and non-contact (terahertz time-domain spectroscopy) between the probe and the graphene film, all of which have been optimized for maximal throughput and accuracy, and minimal damage to the graphene film. Of these three, the main emphasis is on THz time-domain spectroscopy, which is non-destructive, highly accurate and allows both conductivity, carrier density and carrier mobility to be mapped across arbitrarily large areas at rates that by far exceed any other known method. We also detail how the THz conductivity spectra give insights on the scattering mechanisms, and through that, the microstructure of graphene films subject to different growth and transfer processes. The perspectives for upscaling to realistic production environments are discussed.

1. Introduction

In 2006 the price of commercially available single layer graphene was 1 euro per µm². More than a decade after, the price is approaching 1 euro per cm², representing roughly a factor of 10⁸ decrease of the price per area. This development has been made possible due to development of the chemical vapor deposition (CVD) process for synthesis of graphene on copper foils. While high quality graphite-derived graphene products are produced in various ways including oxidation and reduction of graphite [1, 2] and liquid exfoliation [3, 4], CVD synthesis of graphene on catalytic metals is by far the most successful, widespread, and scalable means to produce continuous, high quality graphene films [5]. Epitaxial graphene synthesized by high-temperature sublimation of silicon atoms from a silicon carbide wafer also shows promise [6, 7].

CVD synthesis of macroscopic graphene films has evolved from early pioneering works, with few-layer graphene growth on nickel catalyst demonstrated by several authors [8, 9] followed by demonstration of large-area single-layer graphene synthesis on copper foil by Ruoff and colleagues [10]. Soon after, a roll-to-roll based process showed that single-layer graphene can indeed be fabricated and transferred to essentially square-meter sized substrates [11]. Numerous other roll-to-roll systems have been developed [12, 13], with...
Kobayashi and colleagues demonstrating 100 meter long continuous graphene sheets transferred to a PET polymer substrate. Other large-area graphene strategies include folded or rolled up copper substrates [14]. Recently, several manufacturers of CVD equipment have launched or announced reactors specifically designed for graphene production. Several routes to improving the grain size up to arbitrary sizes have also been demonstrated, and the tendency is that the throughput for these more elaborate growth schemes is increasing as well, including graphene growth on epitaxial germanium [15, 16]. Xu and colleagues [17] showed seamless, epitaxial growth of graphene on the metre-scale on industrial Cu-foil, with carrier mobilities above 15 000 cm²/V·s at room temperature.

The transfer of graphene from the growth substrate has been a subject of considerable research [9, 18–22], since it became apparent that transfer is one of the biggest challenges and bottlenecks for nearly any imaginable graphene-based thin film production scenario. These difficulties include polymer contamination, since many transfer processes involve contact with a polymer film, wrinkles, since the graphene easily becomes folded during the growth and transfer process, and incomplete transfer, which results in macroscopic damage such as tears, gaps, holes and cracks.

For the majority of applications of single sheet graphene in optoelectronics, high-speed, low-power electronics and photovoltaics, the electronic properties are essential. Among the most important key performance indicators (KPI) are carrier mobility $\mu$, sheet resistance $\sigma$, and background doping carrier density $n$.

In terms of electrical characterisation the present-day available means are lagging far behind manufacturing in terms of throughput and quality. The currently dominant way to evaluate the suitability of graphene films for a specific application is electrical field or Hall effect measurements after lithographic patterning of the graphene films into electrical devices. This is generally slow and inefficient, and results in destruction of the graphene film. It is fair to say that as a result, the large area, high density electrical property mapping required for quality control, process optimisation and fundamental understanding, requires considerable effort and is rarely done.

In short, conventional lithographic patterning is less than optimally suited as a serious tool for prototyping and quality control beyond graphene technology’s infancy. The difficulty in obtaining information on homogeneity and consistency is an unacceptable limitation that will become increasingly severe as graphene-based technologies engage in real competition with conventional thin-film, high performance materials.

In this topical review, we will compare three complementary approaches, that each in their own domain provides an attractive trade-off between precision, throughput and spatial resolution for large-area mapping of graphene’s electrical properties—to create KPI-maps:

1. **Fixed contacts**: Dry laser lithography (DLL) which turns a $4''$ graphene wafer into hundreds of separate fixed-electrode devices in 1–2 h. The devices are then measured individually, for instance by a manual or automated probe station.
2. **Movable contacts**: Micro four point probes (M4PP), where metal coated silicon microcantilevers scan across a graphene film to measure the electrical properties in each point.
3. **Non-contact**: Terahertz time-domain spectroscopy (THz-TDS), where the frequency resolved absorption of terahertz radiation across a graphene film is measured without physical contact, and afterwards analysed to extract information of the electrical properties.

In table 1, we make a qualitative comparison of the mapping resolution, the transport length scale, the fabrication throughput, and the measurement throughput, and finally degree of invasiveness of the three methods compared to conventional lithography.

We will also briefly overview other emerging non-contact mapping techniques that provides information on the electrical properties: eddy current testing, scanning microwave impedance and Raman spectroscopy.

## 2. Electrical performance indicators for large-area graphene films

### 2.1. Key performance indicators related to ‘high quality’

In terms of graphene, the key performance indicators and the methods available to assess these have not changed significantly since CVD graphene was introduced: (i) Optical inspection reveals macroscopic damage, contamination and wrinkles. Automated, spectrally resolved microscopy can be used for accurate, quantitative determination of coverage and layer number [18, 29]. (ii) Raman spectroscopy [30], providing an extensive range of information related to graphene quality, via the detailed position, width, shape and relative amplitude of Raman peaks. In particular, narrow 2D- and G-peaks [31], a high ratio of the peak intensities $I_{2D}/I_G$, and the absence of a D-peak [30] are indicators of high uniformity, low coupling to the substrate and a low number of defects, all of which are important for the carrier mobility (see section 5.1.4). (iii) Electrical measurements are typically performed via lithographic patterning of the graphene film into separate test devices, which are followingly contacted by a probe station or by bonding/wiring [18, 24]. The electrical field effect or the Hall effect is then measured to obtain the KPIs.
most directly relevant for electrical and optoelectronic applications, namely the sheet resistance, residual carrier density and carrier mobility, while closer inspection of the transconductance reveals details about the origin of the scattering effects [32].

We make note of certain trends in the field, which we find important. (i) There is considerable variation in not just the methods and norms for comparing quality, but also in the definition of quality. Standardized methods and conventions will immensely help large area graphene to successfully make the transition to commercial production. (ii) Mainstream applications are characterized by widely different requirements and KPIs. For analog and digital electronics, a low doping level is typically desired, while for transparent electrodes a high doping level helps to reduce the sheet resistance [33]. For most types of electronics a high mobility is desired [34, 35], while for graphene-based gas sensors, defects can enhance the chemical reactivity and thus sensitivity to reagents [36]. (iii) To some degree, the set of KPIs considered for a certain application is limited by the availability of suitable methods to characterize them. While, for instance, the spatial distribution and uniformity of the sheet resistance is crucially important for conventional thin films and semiconductors, this is often not discussed or mentioned for graphene and other 2D materials, despite the extreme thinness and exposed nature of the films making these particularly susceptible to external influences and damage. A key reason seems to be the general lack of verified tools and methods suited to characterize the electrical KPIs spatially on a large scale.

2.2. Electrical properties—basic notions and definitions

Electrical resistivity represent the tendency of a material to oppose the flow of charge carriers, while resistance is the measured property of a device, which depends on the size, shape and uniformity of the sample, as well as other factors such as contact resistance. In two dimensions, the resistivity is the measured property of a sheet conductor, is defined as resistance per unit area [33]. For most types of electronics, high mobility is desired [34, 35], while for graphene-based gas sensors, defects can enhance the chemical reactivity and thus sensitivity to reagents [36]. (iii) To some degree, the set of KPIs considered for a certain application is limited by the availability of suitable methods to characterize them. While, for instance, the spatial distribution and uniformity of the sheet resistance is crucially important for conventional thin films and semiconductors, this is often not discussed or mentioned for graphene and other 2D materials, despite the extreme thinness and exposed nature of the films making these particularly susceptible to external influences and damage. A key reason seems to be the general lack of verified tools and methods suited to characterize the electrical KPIs spatially on a large scale.

Table 1. Comparison of different techniques for mapping the electrical properties of graphene.

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<td>Resolution/scale of probed region</td>
<td>1 μm–1 cm</td>
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<td>1–100 μm</td>
<td>0.1–1 mm</td>
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<tr>
<td>Transport length scale</td>
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<td>0.1 mm–1 cm</td>
<td>1–100 μm</td>
<td>10–100 nm</td>
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<tr>
<td>Time per measurement point</td>
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<td>Minutes (with automated probe station)</td>
<td>Ca. 1 min (using CAPRES automated M4PP prober)</td>
<td>&lt;10 ms using commercially available spectrometers</td>
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<tr>
<td>Sample damage</td>
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<td>Destructive</td>
<td>Contact, Non-destructive</td>
<td>Non-contact, Non-destructive</td>
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<td>Contaminations from transfer and device fabrication.</td>
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<td>Contaminations from transfer. Possibility of mapping encapsulated films</td>
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<td>Notes</td>
<td>Device $G, n$ or $\mu$ extracted from field effect or Hall effect measurements. Deep analysis of transport properties and scattering mechanisms at device level at room to low temperatures</td>
<td>Device conductance $G, n$ or $\mu$ extracted from field effect in any position. Hall effect ($n, \mu$) when positioned near edge</td>
<td>Average intrinsic sheet conductivity $\sigma$, $n$ or $\mu$ from field effect or AC-conductivity spectrum in any position. Hall effect when positioned near edge. High-resistive substrates are required for transmission mode THz-TDS, while also conductive substrates are compatible with reflection mode THz-TDS (see section 5.1.1)</td>
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resistance and sheet conductance are the measured quantities, while the sheet resistivity and sheet conductivity are intrinsic material properties, which in certain cases and within a certain error may be determined from the corresponding measured values. This is particularly important, since 2D materials, unlike for instance metals, can have significant spatial variations of the electrical properties, which means that there is no longer a simple relationship between device conductance and material conductivity.

The two-terminal resistance $R_{2T}$ for a rectangular, uniform conductor with width $W$ and length $L$, see figure 1(a), is related by

$$R_{2T} = \frac{L}{W} \rho + 2R_c. \quad (1)$$

The contact resistance $R_c$, which is not necessarily a constant, can be eliminated by using a four-terminal configuration (see figures 1(a) and (b)) with terminals labelled 1, 2, 3 and 4, so that

Here, the placement of the current (1,4) and voltage terminals (2,3) and the shape of the conductor determines the geometrical factor $\alpha$. The Hall bar with the geometry illustrated in figure 1(a) will have $\alpha \approx W/L$ while the case of an inline, equidistant four point probe with current voltage configuration as shown in part A of figure 1(c) is, $\alpha \approx \pi/\ln 2 \approx 4.53$. Equation (2) is also valid for any four-fold symmetric device with contacts on the device boundary such as a circle or square. The van der Pauw (vdp) method [38] allows the geometric factor $\alpha$ in a four-terminal measurements to be eliminated, provided the vdp criteria are fulfilled; contacts should be small compared to the sample size, positioned at the edge and the resistivity must be spatially uniform [38].

Figure 1(b) shows the electrode configurations $A(I_{15}, V_{34}), B(I_{15}, V_{24})$ and $C(I_{12}, V_{54})$, which we will refer...
to throughout the article. The reciprocal configurations are $A(I_{23}, V_{14}), B(I_{24}, V_{13})$ and $C(I_{45}, V_{24})$.

The resistivity $\rho$ for an arbitrarily shaped, uniform 2D conductor is then defined by

$$e^{-\gamma}R_{\parallel}/h = e^{-\gamma}R_{\perp}/h = 1,$$

where $R_{\parallel}$ and $R_{\perp}$ are the resistances measured in two different current–voltage configurations $A$ and $B$. Here $\gamma = 1$ for contacts positioned at the edge and $\gamma = 2$ for in-line, equidistant contacts far away from the edge [39].

For the van der Pauw geometry, the Hall resistance $R_{hi}$, Hall carrier density $n_{hi}$ and Hall mobility $\mu_{hi}$ can be determined by applying a magnetic field $B$ normal to the sample surface.

$$R_{hi} = \frac{R_B - R'_B}{2},$$

$$n_{hi} = \frac{B}{qR_{hi}}, \text{ and}$$

$$\mu_{hi} = \frac{\sigma_{hi}}{en_{hi}}.$$  \hspace{1cm} (4)

For collinear four-point probe measurements on an infinite film, there is no Hall effect, only the Corbino effect due to current rotation.

### 2.3. DC conductivity of graphene

Graphene is a zero-gap semiconductor where the valence and conduction bands meet in 6 Dirac points, at the edge of the Brillouin zone. The six points belong to two sets labelled $K'$ and $K$, as a consequence of the graphene lattice consisting of two inequivalent triangular sub-lattices. The energy dispersion around the $K$ and $K'$-points is linear within 1 eV of the Dirac points. Electrical current in graphene is carried by low energy, massless quasiparticles around the $K$ and $K'$ points, termed Dirac fermions. The electronic structure and transport properties of graphene is covered extensively in literature, e.g. the excellent review articles by Castro Neto et al [40] and Das Sarma et al [41].

The sheet conductivity $\sigma_s$, sheet carrier density $n$ and sheet carrier mobility $\mu_s$, are related by $\sigma_s = ne\mu$. Semiclassical Boltzmann transport theory gives the simple relation [42]

$$\sigma_s = \frac{2e^2}{h} k_F \ell_{\text{af}}$$

where $k_F = (\pi n)^{1/2}$ is the Fermi wavenumber, and $\ell_{\text{af}} = \nu_F \tau$ is the elastic mean free path for a momentum relaxation time $\tau$. Equation (5) can also be obtained by inserting the effective mass of the Dirac fermions [40, 41], $m^* = \hbar k_F / v_F$, in the DC Drude conductivity, $\sigma_s = ne^2 \tau / m^*$. The carrier mobility $\mu = \sigma / (ne)$ can then be written as

$$\mu = \frac{2e}{\hbar} \sqrt{\frac{\pi}{n}} \nu_F \tau$$

where $\nu_F \approx 10^6$ m s$^{-1}$ is the Fermi velocity. Here we note that $\ell_{\text{af}}$ represents the smallest scale at which conductivity has any meaning; below this scale, the transport is ballistic and non-local.

The carrier mobility $\mu$ and residual carrier density $n$ are usually determined by a field effect or a Hall effect measurement with a rectangular or quadratic sample geometry, see figure 1(d). In the field effect measurement, the carrier density $n = CV_d/\epsilon$ is varied by a gate voltage $V_d$. Here $C = \epsilon_0 \epsilon / 2$ is the capacitance per area of the capacitor formed by the graphene and the gate electrode, separated by a dielectric layer of thickness $t$ and permittivity $\epsilon$. This approximation only holds if the linear dimensions of the overlap area between gate and graphene are significantly larger than the spacing $t$, so that the electric fringe fields can be ignored.

In addition to the plate capacitance, the low density of states $D$ of materials such as graphene leads to a contribution from the quantum capacitance $C_Q = e^2 D$ that can be neglected for typical silicon oxide dielectric layers with thickness in the 90–300 nm range, but can be significant for very thin gate layers [43]. Assuming electrical homogeneity, $(W/L)G = G_0 = \sigma_s$, the field effect mobility $\mu$ can be estimated from the slope of the measured conductance as a function of gate voltage (see figure 1(e)),

$$\mu \approx \frac{1}{C_{\text{ox}}} \frac{L}{W} \frac{\Delta G}{\Delta V_d}.$$  \hspace{1cm} (7)

The discussion of different methods for extracting carrier mobility is covered by numerous authors [44–46]. The residual carrier density, $n_0 = \epsilon_0 \epsilon / D V_{\text{Dirac}}(n)^{3/2}$, is determined from the gate voltage offset $\Delta V_{\text{Dirac}}$ of the gate voltage corresponding to the minimum conductance, $G_{\text{min}}$.

### 2.4. Scattering mechanisms and mobility of CVD graphene

Graphene grown by CVD is often transferred by wet transfer, with the copper either etched [10] or delaminated [18], using a polymer film as a mechanical support. The residual carrier density of the final device may be influenced by numerous factors, including doping by gas and water molecules adsorbed on the surface or trapped between the graphene and the substrate [47, 48], polymer residues from the transfer or lithographic processes [49], and surface treatments of the substrate (i.e. O$_2$ plasma) [50]. Trapped charges in the oxide as well as water molecules and other polar molecules can lead to dynamic (hysteretic) variations in the total carrier density through capacitive gating or charge transfer [47].

Many of these factors also contribute to reducing the carrier mobility through different scattering mechanisms. Most of the above external influences can be described by some form of charged impurity (ci) scattering. The scattering time for charged impurity scattering has a square-root dependence on the carrier density, $\tau_{ci} \propto \sqrt{n'/n_{imp}}$, where $n_{imp}$ is the density of charged impurities [51]. Comparison with equation (6) gives the frequently observed linear relation between the conductance and the gate voltage in CVD.
graphene, where the carrier mobility remains roughly constant, see equation (7). Tears, cracks, and grain boundaries produce point-like defects, which according to Chen et al [52] give rise to strong short-range scattering potentials, \( \tau_s = (2e^2/\pi \hbar) (n/h_c) \ln^2(\hbar k R) \), which by insertion in equation (6) gives a nearly constant mobility \( \mu = n_e (2e/\pi \hbar) \ln^2(\hbar k R) \). Here \( R \) is the radius of the point-like scattering potential, and \( n_e \) is the defect density.

Even in the absence of defects and contamination, electrons will scatter on intrinsic longitudinal acoustic phonons (LA), or, depending on the substrate, interact with substrate phonons (S) such as the polar optical phonons in SiO\(_2\). This leads to a Matthiesens-rule expression for the total scattering time [53],

\[
\tau_{\text{tot}}^{-1} = \tau_{\text{LA}}^{-1} + \tau_{\text{S}}^{-1} + \tau_{\text{sr}}^{-1} + \ldots, \tag{8}
\]

which is proportional to the carrier mobility, see equation (6).

After transfer to the target substrate, typical values for the carrier mobility are in the range of 500–5000 cm\(^2\)V\(^{-1}\)s\(^{-1}\) with residual doping levels of \(10^{12}–10^{13}\) cm\(^{-2}\). These values are far below the limit of approximately 40000 cm\(^2\)V\(^{-1}\)s\(^{-1}\) imposed by polar optical phonon scattering by the silicon dioxide [54], as well as the ca. 120 000 cm\(^2\)V\(^{-1}\)s\(^{-1}\), which represents the upper limit at room temperature, limited by longitudinal acoustic phonon scattering [41]. By careful optimization of growth and transfer, room temperature mobilities of 5–12 000 cm\(^2\)V\(^{-1}\)s\(^{-1}\) were measured in high vacuum on Si/SiO\(_2\) [55]. Chen et al [56] found that for high quality graphene on a SiO\(_2\) substrate, charged impurity scattering is dominating.

With the increase of CVD grown graphene single crystals to cm-scale [57, 58] and general improvement of the large-area synthesized graphene films processes, one of the main limiting factors for graphene device quality is the transfer process. Encapsulation of graphene can greatly reduce the residual doping level and hysteresis, reduce the impurity and electron–phonon scattering, as well as provide stability towards changes in environmental conditions. While CVD graphene has been demonstrated to match the best exfoliated graphene devices produced by dry transfer (avoids water and solvents) with support [59] or by full encapsulation [20] in hexagonal boron nitride, a scalable route to high quality encapsulation is still highly desired. Hexagonal boron nitride encapsulation provides at the same time protection against doping by gas molecules and water molecules, polymer residues, lithographic damage, substrate phonons (compared to SiO\(_2\)), and has been shown to reduce the roughness of graphene to extremely small values (12 pm) [60]. Following, it is imperative to develop large area encapsulation based either on high quality CVD processes for hexagonal boron nitride [61–63], or reasonable alternatives, including atomic layer deposition [64] or self-assembled monolayers [56, 65], or combinations of these. Without encapsulation, CVD graphene materials are not likely to reach carrier mobilities better than 5000 cm\(^2\)V\(^{-1}\)s\(^{-1}\), and time will show how much improvement cost-effective, large-area encapsulation schemes can provide. For applications such as electrodes, the sheet conductance can be increased via doping. CVD graphene can reach sheet resistances of order 100 \(\Omega\) using surface doping with FeCl\(_3\) or Au doping of monolayers [66], or towards 20 \(\Omega\) for FeCl\(_3\) intercalation in multilayer graphene [67].

2.5. AC conductivity for pristine and structured graphene

While the absorption of electromagnetic radiation in the visible spectrum is a constant 2.3% in single-layer graphene [68] and dominated by interband scattering, the photon energy is much smaller (meV) in the terahertz range, leading to predominance of intraband scattering of charge carriers, see figure 2. In this frequency range, the optical response of graphene is comparable to that of an electron plasma (or metal-like), while the optical conductivity of graphene is surprisingly well described by the same functional form as the classical Drude model [69]. The main assumptions behind the Drude model are that charge carriers are accelerated by an external field \(\mathbf{E}\), \(\mathbf{v} = -\mathbf{E}/\hbar m\), that scattering events are instantaneous and isotropic with an average scattering time \(\tau\), and that there is no interaction between charge carriers. Based on these assumptions, the Drude conductivity spectrum of a metal or a doped semiconductor is

\[
\sigma(\omega) = \frac{\sigma_{\text{dc}}}{1 - i\omega \tau}, \tag{9}
\]

where the DC conductivity is given by \(\sigma_{\text{dc}} = ne^2/\hbar m^*\) and \(\omega = 2\pi \nu\) is the angular frequency. While Dirac fermions have zero rest mass, the quantum-mechanical treatment within Boltzmann transport theory of the electrodynamic response of graphene shows that the optical conductivity in the THz range has a Drude-like spectral shape [70, 71], with the DC conductivity given by the Boltzmann result, equation (5) [72].

THz time-domain spectroscopy measures the transmission amplitude and phase through a sample, which can be used to extract the spectral shape of the conductivity spectrum and thus allows the DC conductivity and the scattering time to be extracted by fitting with equation (9). From these primary parameters, the carrier concentration and the drift mobility can then be calculated as will be discussed in section 5.7.

The Drude picture can be successfully extended to describe more complex scattering scenarios. In the simple Drude picture, the assumption of point-like, isotropic scatterers works well for high quality graphene on silicon dioxide substrates, where charged impurities tend to dominate, see section 2.4. The situation can be quite different for graphene grown by more application-relevant processes, where polycrystalline copper foil is used, and the growth rate is accelerated to give the highest possible throughput. Such graphene films will tend to be polycrystalline in nature, with crystal domain sizes and orientations determined
by multiple factors, including purity, smoothness and orientation of the substrate, as well as the growth conditions. Additionally, defects during post-growth transfer to other substrates may introduce folds, buckles, rips and tears in the film. These types of defects share the common feature that they are extended, or line-shaped, and results in scattering profiles that differ qualitatively from isotropic.

Line-shaped defects generally lead to predominance of backscattering. As the characteristic dimensions of the crystal domains in graphene approaches that of the mean free path $\ell_{\text{mfp}}$ the carriers will be subject to significant backscattering on the domain boundaries in addition to point-like impurity scattering. As discussed by Smith [74], this increased probability of backscattering of the charge carriers can be seen as a sign reversal of the current impulse response function (IRF), which in the Drude model is a simple exponential function. $j(t)|_{\text{Drude}}(0) = \exp(-t/\tau)$. The Drude conductivity spectrum (equation (9)) is the Fourier transform of this IRF. With a modified IRF of the form $f(t)|j(0) = (1 - ct/\tau) \exp(-t/\tau)$, the corresponding conductivity spectrum is

$$\sigma_{\text{DS}}(\omega) = \frac{W_0}{1 - i\omega\tau} \left( \frac{1 + c}{1 - i\omega\tau} \right),$$

a relation known as the Drude–Smith conductivity [74]. The parameter $c$ describes the amount of backscattering ($-1 \leq c \leq 0$). The Drude model is recovered for the case of no preferential backscattering, $c = 0$, and $c = -1$ describes backscattering of every electron trajectory during one cycle of the AC-field. The DC conductivity then becomes $W_0(1 + c)$, where $W_0 = ne^2/\tau m^*$ (the Drude weight) can be understood as the local, intrinsic DC conductivity between the line defects.

For maximal backscattering, $c = -1$, the DC conductivity is completely suppressed, as could be expected for a macroscopic surface with charge carriers strictly confined to small domains. There is no straightforward link between the backscattering parameter $c$ and the microscopic structure of the conductive film, and as such, the model is phenomenological by nature, in the same way as the original Drude model. However, under certain simplified conditions (identical, isotropic and spherical domains), the backscattering parameter can be linked to the charge reflection probability as $c = -p_f/(1 + \alpha/2)$ where $\alpha$ is the ratio between the domain size and the mean free path $\ell_{\text{mfp}}$ [75]. Hence, while equation (10) is a solid phenomenological basis for characterization of the conductivity of extended graphene films [26] as well as other nanostructured conductors [76] and semiconductors [77–80], the Drude–Smith model represents a highly simplistic picture of the complex interaction between Dirac fermions and line-defects, and its impact on the AC conductivity. Further investigations into the validity range of the Drude–Smith model as well as more specific models taking disorder explicitly into account are certainly needed for a detailed understanding of conductivity dynamics in the presence of disorder in graphene.

2.6. Electrical uniformity and continuity of large area graphene

It is clear that nearly any commercial applications of graphene that rely on the electrical properties cannot accept significant variability from sample to sample, nor within same sample. For instance, sheet resistivity variations in large area electrodes leads to inconsistent light emission of light emitting diodes [81].

As mentioned in section 2.3, the measured sheet conductance is strictly equal to the intrinsic sheet conductivity $\sigma$ only in the case of perfect electrical uniformity. In the majority of published literature
discussing methods for growth, transfer or passivation/encapsulation for graphene, the uniformity is stated simply as a range of $\sigma_n, \rho$ and $n$ values measured across several devices, with an indication of statistical spread, or sometimes histograms [18, 55].

For large area graphene, the average and the statistical spread itself are generally insufficient descriptors of uniformity. Growth and transfer processes can give rise to long-range spatial variations that need to be understood and monitored, and have non-trivial impact on the electrical characteristics. For instance, temperature or gas flow fluctuations or variations in a CVD reactor or the geometrical circumstances of a transfer procedure, can translate into spatially dependent variations in doping density as well as grain structure. In lieu of spatially resolved electrical measurements, optical microscopy and micro-Raman microscopy are used to assess and compare the uniformity (see figure 6). While certainly relevant [82], it is doubtful that such indirect characterisation techniques can fully replace direct measurement of the conducting properties.

Conductivity variations can be decomposed into carrier density and carrier mobility variations [24, 27, 83],

$$\sigma(x, y) = n(x, y)\mu(x, y).$$

(11)

The vdP theorem, equation (3), requires the device to have no variations of $(n, \mu)$ within the boundaries of the sample. A crack or a tear crossing the boundary of the sample will not violate the basic assumptions; in this case the sample can be regarded as simply having a different, more irregular shape. In contrast, an internal tear or hole will indeed lead to errors in the estimation of $\sigma$ [84].

The electrically measured sheet conductance (sheet resistance) is strictly different from the conductivity (resistivity) of a graphene film, and these differences can lead to non-trivial errors when changing the carrier density with an electrostatic gate. Due to the ambipolar behavior of graphene, spatial variations in $n$ or $\mu$ on the same scale as the sample size will lead to inhomogeneous current flow as a function of gate voltage, as different regions of the graphene sample become more or less conducting at different gate voltages, see figure 3(a). In this case, the effective shape of the sample is gate-voltage dependent, making determination of carrier mobility or density from the gate-voltage dependent conductance prone to systematic errors, as we showed recently in [85]. Following our previous work [26] we refer to this aspect of uniformity as electrical continuity.

Figures 3(a)–(d) shows four different scenarios. In figure 3(a) the conductivity is non-uniform with a slow variation, but no disruption of the current flow. In figures 3(b) and (c) a line defect is crossing the current path. If the line is semitransparent, as for instance most grain boundaries, current can still be transmitted across the defect (b), while for a tear or crack, the current may be disrupted entirely. Figure 3(e) shows a simulation of an electron wave packet spreading out from a point current source in polycrystalline graphene, while experiencing partial reflections at the grain boundaries, in analogy to the illustration in figure 3(b). Figure 3(f) shows calculations of current flow in a graphene sample using a resistor network model, where each resistor represents an area of graphene with a local carrier density and carrier mobility, and conductivity given by $\sigma = n\mu$. The lines represent areas where the conductivity of the resistors have been reduced to 5% and 1% compared to the rest of the structure, resulting in a dramatic difference in how the current flow is redirected.

The spatial distribution of any number of insulating defects can have a large impact on current transport. In one cm$^2$ of graphene, one missing line of atoms across the film, while just amounting to 1 out of 80 million atoms, will prevent current flow, except for possibly quantum tunneling across the 1 atom wide gap. On the other hand, when distributed uniformly, figure 3(d), the exact same amount of defects will have virtually no influence on the transport properties, as the resulting 1 vacancy per 1.5 $\mu$m$^2$ per graphene is orders of magnitude lower than the point defect levels studied by Cancado et al [86]. This trivially reflects that line defects and point defects have very different impact on the measured KPIs, and that the average defect density itself is an unreliable predictor of the electrical performance unless the defect distribution is also considered.

For lithographically patterned graphene films, it is relevant to distinguish between uniformity and continuity on inter-chip and intra-chip level. On the inter-chip level, the statistical and spatial variations of the conductance, carrier density and mobility can be compared across the wafer. The intra-chip uniformity can be assessed by the van der Pauw method, by comparing electrical measurement of the resistance in different current voltage configurations with the theoretical result from a perfectly uniform sample. We introduce the uniformity parameter, $\beta_j = R_j/R_p$ where $i$ and $j$ represent two different current–voltage configurations. For a four-point probe measurement far from the edges, figure 3(g), $\beta_{AB} = 1.26$, while for the case of a symmetric van der Pauw square-shaped sample, figure 3(h), $\beta_{AC} = 1$. In both cases, a closer inspection of this ratio can reveal information on the type of non-uniformity, i.e. whether the origin is point- or line-defects [25, 26, 87], and whether the observed variations are dominated by doping or mobility variations [85].

Finally, the scale at which non-uniformity occurs is important; 500 nm graphene domains with high resistive grain boundaries, may lead to strongly irregular current paths for submicron devices, but can appear homogeneous on mm-scale where many statistically similar domains are averaged.

### 3. Mapping with fixed contacts

The most common form of providing information on the electrical properties of large-area graphene
devices is by fixed lithographic contacts. Although spatial information can be obtained by stepping a set of probes from device to device, electrical parameters for many devices is often presented simply as histograms without information regarding the spatial distribution. The three main problems of fixed lithographic contacts as a method to perform electrical characterisation are (i) long turn-around time, (ii) influence of the fabrication process chemistry on the electrical properties and (iii) the destructive nature of lithographic contacts, as turning a graphene film into test samples will permanently prevent further use in nearly all cases.

3.1. DLL—dry laser lithography
To address the issues of contamination and limited turnaround time of conventional lithography [89–91], laser ablation can replace lithographic patterning for shaping the graphene film, while a physical stencil mask can replace lithographic patterning for depositing metal electrodes. Nanostencil lithography is a highly versatile technique that has been studied extensively over the past decades. Advantages count reduced contamination and possibility of processing finished devices, while known issues include multilayer alignment and clogging of small apertures. An excellent review of nanostencil lithography, which describes the challenges as well as possible solutions, is given by Vasquez-Mena et al [92]. Stencil lithography was previously used to make high quality graphene devices [93] and for systematic investigations of the influence of lithographic processing on electrical performance for graphene on SiO₂ [91]. The technique used here combines stencil lithography with direct laser writing, which we term DLL (dry laser lithography) [23, 24]. The process time can be reduced to less than an hour per wafer limited by time required for wafer alignment and metal evaporation; the total writing time can be on order of minutes. Since neither water, solvents or polymers are brought in contact with the graphene, the

Figure 3. (a) Non-uniform, electrical continuous sample with slowly varying non-uniformity. (b) Sample with semitransparent line defects. (c) Reflecting line defects. (d) Point defects. (e) Simulation of electron wave packet expanding out through grain boundaries and experiencing partial reflection, courtesy of Aron Cummings and Stephan Roche, see e.g. [88]. (f) Resistor network calculations of current flow in graphene with line defects with 5% or 1% assigned conductivity compared to the rest of the area with sheet conductivity σ. Comparison of current–voltage configurations can be used to detect non-uniformity in samples, where (g) βA ≈ 1.26 for a uniform sample measured by four point probes and (h) βA,C = 1 for uniform square samples with symmetric contact configurations as shown. (i) and (j) Uniformity on larger scale than the individual device (inter-device uniformity) can be tested by scanning the probes, either directly on the graphene film or (j) on lithographic contact pads connected to electrodes on patterned devices.
film is as pristine as the handling and transfer process allow. Apart from serving as a fast prototyping and test method, it also provides a reference for comparison with non-contact methods [24], see section 6.

To pattern the graphene as well as for machining the physical shadow mask, a Micromac AG microSTRUCT vario laser micro-machining system was used. First, an array of large Au electrodes was deposited through a physical shadow mask. To establish the optimal laser fluence parameters for three different wavelengths (355 nm, 532 nm and 1064 nm) the single 10 ps pulse fluence was increased from about 1 to 300 mJ cm$^{-2}$ until the onset of graphene ablation was detected, by noting when the electrical resistance between the electrodes increased towards infinity. A range of laser fluence values could be established for all three wavelengths, where the graphene is fully removed without damaging the SiO$_2$ surface. This was confirmed by optical microscopy, micro-Raman spectrometry, stylus profilometry and electrical measurements, as summarized in figure 4. By optimizing the fluence and the pattern layout to only consist of line cuts, the writing time could be reduced to less than 1 s per device.

### 3.2. Uniformity analysis

The uniformity and quality of lithographically defined samples can be analysed in some detail following the strategies outlined in section 2.6, using the uniformity parameter $\beta_{MC} = R_A/R_c$ for the two measurement configurations A and C in figure 3(h). A set of 47 working (5 mm × 5 mm) samples was fabricated by DLL and measured in both configurations to establish the conductance, the field effect mobility, and the Hall mobility in a transverse magnetic field. Uniformity and continuity was assessed from the deviation of the $\beta_{MC}$ ratio from unity. Out of the 47 samples, 20 samples had $\beta_{MC}$ value between 0.9 and 1.1, indicating high uniformity. For these devices, typical figure-of-merit values at zero gate bias voltage were a sheet conductance of 3 mS, Hall mobility of 800–1000 cm$^2$ V$^{-1}$ s$^{-1}$ and a zero-gate bias carrier density of approximately $10^{13}$ cm$^{-2}$, representing a fairly high residual doping level. These results are directly compared to THz-TDS measurements in section 6.1.3.

Figure 5(a) shows how the variation of $\beta_{MC}$ is an indicator of the effective sample aspect ratio, in this case from 1 (square) towards rectangular. In figure 5(b) the deviation of the uniformity parameter $\beta_{MC}$ from unity is illustrated schematically for a geometrical, gate-independent contribution, $\beta_{MC}(G)$, and/or a gate-dependent contribution, $\Delta \beta_{MC}$. While $\beta_{MC}(G)$ originates from tears, cracks and holes (disruptions), which change the effective geometry of the sample, non-uniformity in carrier mobility and carrier density, however, will lead to gate-dependent variations. In figures 5(c) and (d) the sheet resistance $R_s$ and uniformity $\beta_{MC}$ of a graphene
A device measured in dry N₂ atmosphere conditions is shown. In comparison, an exfoliated graphene device fully encapsulated in hexagonal boron nitride using methods described in [94], shows far smaller uniformity variation $\beta_{AC}$, see figures 5(e) and (f). Figure 5(g) shows a result of a finite element simulation for a sample, using the carrier density estimated from the Raman G-peak linewidth [95] to estimate the carrier density, see figure 5((g), inset). The simulated (dashed) curves agree reasonably well with the experimental (full) curves. Figure 5(h) shows the result of Monte Carlo simulations of 40 devices with random, spatial carrier density variations. Adapted from [85].

4. Mapping with movable contacts

Despite the mechanical strength of graphene, its atomic thinness makes the films very fragile, and susceptible to damage upon physical contact. Conventional millimeter-size spring-loaded tungsten tips used for mapping of sheet resistivity of silicon wafers, are difficult to use on graphene films without causing unreliable measurements, if not irreversible damage.

4.1. Micro-four point probes (M4PP)

The micro four-point probe (M4PP) was introduced in 2000 as an ultra-compact, non-invasive alternative to conventional automated four-point probe systems, suitable for characterisation of thin films and fragile surfaces, with a far better spatial resolution, increased surface sensitivity, as well as reduced damage and contamination [96]. The M4PP is a silicon chip with multiple (typically 4 or 12) micro-fabricated metal-coated cantilever electrodes. Multiplexing of the current and voltage probes allows for multiple current–voltage configurations to be measured in a single engage. This allows a system to detect measurement inconsistencies, which can be caused by non-uniformity of the samples, and can also provide insight into the scale of spatial variations, as was done for characterization of laser annealed ultra-shallow junctions [97]. The M4PP has been used for a large variety of low dimensional systems, including surface reconstructions in ultra-high vacuum (UHV) [98], self-assembled polymer films [99], carbon nanotubes [100], metal nanowires [101] as well as industrially relevant systems such as magnetic...
tunnel junctions and ultra-shallow junctions [83]. Compared to the classic theory of four-point probe measurements [102], substantial progress has been made with respect to error-correction and sensitivity analysis, as well as new measurement concepts such as the micro Hall method [103] which is also applicable to graphene. M4PP today ranks with fixed lithographic electrodes in terms of precision and repeatability for both sheet resistance and Hall effect measurements [104], while being non-invasive and superior in terms of throughput. Automated M4PP mapping was first introduced for mm-size self-assembled poly-thiophene monolayer [99] and later used for mapping of the carrier density and mobility of graphene [24–27]. Alternative approaches to conductivity mapping include multi-tip scanning probe systems [105–108], which have less relevance for large area graphene due to a low throughput.

Figure 6. (a) SEM image of micro 12-point probe. (b) M4PP with four cantilevers and strain sensor for contact detection. (c) Optical image of a 6 × 8 mm graphene film grown on polycrystalline Cu foil (sample ‘Cu foil 1’) where the transfer process was imperfect, and several damaged areas are clearly visible. (d) The Raman spectrum intensity peak ratio (I(D)/I(G)) map shows much less features than the (e) I(G) map, which suggests that the macroscopic damage (tears, gaps, holes, cracks) dominate over structural (atomic scale) defects. (f) The conductivity map is very similar to the I(G) peak map. (g) Resistance ratio \( R_{x}/R_{y} \) map. (h) Histogram of \( R_{x}/R_{y} \) values for sample ‘Cu foil 1’ (red bars) and sample ‘Cu111’ (green bars), where the ‘Cu111’ (CVD graphene on single crystal Cu catalyst) is showing a far better agreement with the prediction for continuous graphene. Adapted from Buron et al [25].

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4.2. Conductance mapping with M4PP

Commercial tools for fully automated M4PP mapping of 100 mm to 300 mm wafers with automated wafer as well as probe changing (in case of wear or failure), have been developed and are routinely used in the semiconductor industry\(^6\). To allow for fully automated measurements on CVD graphene without 100% coverage mechanical surface detection is achieved by on-chip integrated strain gauge sensors [83].

Figure 6(a) shows a 12-point probe useful for measurements at different length scales. Figure 6(b) shows a M4PP with a strain sensor for contact detection, hovering above a graphene flake.

Figure 6(c) is an optical micrograph of a CVD grown graphene sample ('Cu-foil 1') where the transfer to the SiO\(_2\) substrate was imperfect, leaving several cracks and holes in the structure. Even within the areas with clear macroscopic damage as revealed in the Raman G-peak intensity map (figure 6(e)) the \((I(D)/I(G))^{-1}\) ratio shows only minor variations, underlining that the \(I(D)/I(G)\) ratio alone is insufficient to evaluate the impact of defects on the electrical continuity of the graphene film.

Figure 6(f) shows a conductance map with 4000 measurement points, recorded with a 10 \(\mu\)m pitch M4PP and a step size of 100 \(\mu\)m. There is a high resemblance of the G-peak intensity map and the M4PP conductance map, showing that the coverage of graphene is the main source of the conductance map variations. Figure 6(g) shows a color map of the uniformity parameter \(\beta_{AB}\), which is described in the following section.

4.3. Uniformity analysis with M4PP

The histogram (figure 6(h), red bars) of the \(\beta_{AB}\) ratio corresponding to the data in figure 6(f), shows a clear deviation from 1.26 for homogeneous graphene [25], even taking into account statistical spread from variations in probe distance, as calculated by Monte Carlo simulations (black curve). In comparison, the \(\beta_{AB}\) data from sample ‘Cu111’, single-crystal Cu transferred by non-destructive electrochemical transfer [18], is in much better agreement with the expected distribution for undamaged graphene.

Any inhomogeneity in the vicinity of the four point probe may change the current flow, which in turn leads to deviations in the measured voltages, as discussed in section 2.6. Lotz et al [87] studied the deviations of the \(\beta_{AB}\) ratio from the nominal value of 1.26 for a homogenous 2D film, in the presence of line defects using Monte Carlo based finite element calculations. The study showed that a moderate number of line defects introduces a significant spread of \(\beta_{AB}\) values, and that strong line disorder leads to a collapse of \(\beta_{AB}\) towards unity, where the current flow between the current probes favors a single quasi-1D pathway.

\(^6\) The company CAPRES A/S, a spinout of the Technical University of Denmark, manufactures fully automated system based on micro four point probes (www.capres.com).
regardless of the current–voltage configuration. Typical current flow patterns in 2D conductors with representative arrangements of line defects from the Monte Carlo ensemble are shown in figure 7(a), for 0.09 and 4.00 defects per area measured in units of square probe spacing, $s^2$. As the density of line defects is increased, the distribution of $\beta_{AB}$ values shift from being centered around 1.26 to being collapsed onto 1.00. Comparison with the statistical distribution of $\beta_{AB}$ values in figure 6(h) shows a striking resemblance, which corroborates the interpretation that the electron transport in the incompletely transferred CVD graphene film, undergoes a transition from 2D-like (uninhibited) to 1D-like (percolative) current flow in the most damaged parts of the graphene sample. In the latter case, the current path is nearly unaffected by the change between current terminals corresponding to A and B configurations, which results in $\beta_{AB} = 1$. Figure 7(c) shows the corresponding case of closed, semitransparent line defects, which can be used to model grain boundaries in graphene. The transition from low defect density where the current flow is an approximating uninhibited 2D current flow, to a collapse towards 1D-like current flow for higher defect density, resembles the situation for open line defects. However, when the grain size becomes so small that the material appears uniform on the scale of the probe spacing, the $\beta_{AB}$ distribution is recovering towards the 2D value, $\beta_{AB} = 1.26$, as indicated by the white arrow in figure 7(d) for 9 grains per $s^2$.

Comparing the statistical distributions in figures 7(b) and (d), it is not clear whether the open defects or closed defects model describes the data best; the data is equally well described by a mix of the types of behavior shown in figure 7.

5. Mapping without physical contact

In terms of mapping the electrical properties of graphene with a reasonable compromise between speed and accuracy, terahertz time-domain spectroscopy is the most well-studied in scientific literature, in addition to which commercial solutions for large-scale conductivity mapping of CVD graphene already exist\(^7\). For general overview of the terahertz properties of graphene, we recommend [71, 110]. In this section, the main focus is to overview the relevant terahertz based methodologies and results in terms of mapping the electrical KPIs of large-scale graphene films. However, several other complementary non-contact electrical characterisation and mapping techniques are under development. We will briefly overview these in the context of electrical KPIs, before focusing on terahertz-based methods.

5.1. Emerging non-contact techniques

5.1.1. Terahertz based techniques

Terahertz time-domain spectroscopic measurement of electrical conductivity can be carried out by measuring the attenuation of a terahertz pulse by transmission through the sample (transmission-mode) or by reflection back (reflection-mode) from the sample. As discussed in much more detail in section 5.2, this attenuation can be translated to sheet conductivity. Conductivity maps are then formed by scanning the wafer with respect to the THz transmitter and receiver. Conceptual schematics of transmission and reflecting (reflection-mode) THz-TDS spectroscopy. Source: www.das-nano.com

\(^7\) The company Das Nano manufactures the systems for graphene conductivity mapping, based on reflection-mode THz-TDS spectroscopy. Source: www.das-nano.com
reflection mode THz-TDS are shown in figures 8(a) and (b), alongside examples of conductivity maps of CVD graphene on Polyethylene terephthalate (PET) and sandwiched between polyethylene (PE) layers, respectively. The conductivity map in figure 8(a) is recorded with the setup described in section 5.2, and illustrated in figure 9(b). The horizontal stripes are only visible in the conductivity map and originates from mechanical damage caused by the packaging box used to store the PET/CVD film. The conductivity map in figure 8(b) is recorded with a Das Nano Onyx reflection-mode THz-TDS mapping system. Reflection-based THz-TDS is less well-established and more complex than transmission-based THz-TDS, but has the advantage that the much wider range of terahertz absorbing (conducting) substrates can be used, as recently demonstrated [28].

5.1.2. Eddy current
Another promising approach is eddy current (EC) measurements, where an induction coil is scanned across a thin film, while generating an oscillating magnetic field. This leads to eddy currents in the conductor, and the absorbed power can be converted into a DC voltage, which in turn is used to estimate the conductivity of the conductor [111–113].

While there have so far not been any examples in scientific literature of EC-based maps of graphene conductivity or other electrical properties [117], EC-based conductivity mapping methods and systems have long been known in the semiconductor and thin film industry [114]. Commercial manufacturer Sarasgus produces EC-based conductivity mapping systems that have been successfully demonstrated with wafer-scale graphene samples that can map sheet resistance
with accuracy below 5% in a wide resistivity range, with a throughput corresponding to scanning of a 12" wafer in 30 min at a pitch of 1 mm. Figure 8(c) illustrates the eddy current technique, with a conductivity map (40,000 measurement points) recorded by a Suragus EddyCus TF map 2525. In this setup, the secondary magnetic field generated by the eddy current is measured by a pickup-coil. By reducing the size of the sensors and thus the distance to the surface, the resolution can be reduced to the submicron scale [115], so this technique appears to offer a wide range of possibilities for adapting to different application scenarios. Similar to the micro four-point probe, the method allows information on the large-scale homogeneity of the sample to be extracted as well, since disruptions such as cracks, force the eddy currents to pass around the obstacle, which can be detected as a shift of impedance [113].

5.1.3. Microwave impedance

The surface impedance and sheet resistance of graphene films on different substrates can be evaluated by induced shifts of the frequency and quality factor of a suitable electromagnetic cavity resonance, either by placing the sample inside the cavity at a field maximum [112, 116, 117] or in the evanescent near-field zone of an opening in the cavity [118], allowing spatial resolution in the nanometer range [119]. A more advanced version of the microwave resonator system was able to measure the average conductance of large areas nearly instantly, however without any spatial information [118, 120]. By localizing the probe area using a copper housing with a small opening and a sapphire microwave resonator inside, large-scale conductivity microwave impedance maps of graphene were obtained, see figure 8(d). In this scan, the time per measurement was 100 ms, and the reproducibility was found to be of order 1%, with uncertainties due to substrate thickness variations and permittivity below 10%. The resolution is given by the size of the resonator, which at present is between 5 to 20 mm, and for which pitch ranges between 3 to 15 mm are relevant, respectively. Microwave impedance-based conductivity mapping have a strong potential for fast, non-contact imaging of the electrical properties of graphene and other 2D materials.

5.1.4. Micro-Raman spectroscopy

Raman spectroscopy is a widespread and well-established method for obtaining quantitative information about defects, disorder, strain, doping, number of layers in graphene sheets [30], all of which are known to affect the electrical properties. Graphene has two main characteristic peaks, which for a 532 nm laser are visible at approximately 2675 cm\(^{-1}\) (2D peak) and 1580 cm\(^{-1}\) (G peak).

The occurrence of a third peak (D-peak at 1350 cm\(^{-1}\)) in the Raman spectrum indicates the presence of sp\(^3\) bonds, and is typically associated with structural defects in the basal plane of graphene, including edges with armchair orientation. Disorder can be quantified through the \(I(\text{D})/I(\Gamma)\) peak intensity ratio, which is related to the average distance between defects [121, 122]. For low to moderate disorder levels, a higher \(I(\text{D})/I(\Gamma)\) ratio means higher disorder in the system, which has been shown to correlate with lower carrier mobility in certain graphene systems [30].

The full width at half maximum (FWHM) of the graphene 2D-peak (\(\Gamma_{2D}\)) can be used as an indicator of strain variations in graphene, which is linked to the mobility of graphene for high-quality devices, such as epitaxial graphene on SiC [123] as well as exfoliated graphene on SiO\(_2\) and on hexagonal boron nitride [31, 82, 91, 124]. A decrease in \(\Gamma_{2D}\) correlates with an increase in mobility due to less lattice deformation, which also seems to hold for CVD graphene grown on Cu substrates [20]. Accordingly, the \(I(2\text{D})/I(\Gamma)\) peak intensity is suggested to be an indicator of carrier mobility limited by charged impurity scattering [125]. For larger doping levels (\(> 2 \times 10^{12} \text{ cm}^{-2}\)) the peak positions of the 2D- and G-peaks are more sensitive to doping, and can give information on doping levels and doping polarity (\(n\) or \(p\)) of graphene, while for smaller doping levels, the \(\Gamma_{G}\) or the \(I(2\text{D})/I(\Gamma)\) intensity peak ratio are better predictors of doping [95, 126].

Overall, Raman spectroscopy is invaluable for obtaining information essential for understanding and interpreting the electronic properties of graphene films and devices. The Raman spectrum is clearly affected by the carrier doping and mobility, however, but are not translated to electrical KPIs in any straightforward manner. Due to the widespread availability of high quality micro-Raman spectroscopy equipment in the graphene research field, further progress in establishing traceable links between quantitative micro-Raman microscopy and the electrical KPI’s of graphene will be of great importance.

5.2. Transmission-mode terahertz time-domain spectroscopy

THz-TDS is a method for determination of the complex-valued dielectric response of a material in the THz frequency range. We consider here exclusively THz-TDS based on transmission of terahertz pulses through the sample, as depicted schematically in figure 8(a).

The technique relies on femtosecond laser-based generation and synchronized, time-resolved detection of the electric field \(E(t)\) of an ultrashort electromagnetic pulse with spectral components covering part of the THz spectral range [127]. Custom-built laboratory THz-TDS systems based on two-color femtosecond laser-induced plasmas [128–132] deliver spectroscopic results well into the multi-ten THz range [78, 133–138], see figure 9(a).
With precise detection of the temporal waveform, a THz-TDS system gives access to the amplitude and phase of the signal within its useful bandwidth. Figure 9(b) illustrates a much cheaper and simpler, typical commercial spectrometer (from Picometrix, Inc.) based on photoconductive antennas which is capable of generation and detection in the range 0.1–4.0 THz. Figure 9(c) shows the system during scanning of a graphene coated silicon wafer, resulting in a map of the conductivity as shown in figure 9(d), together with a coverage map calculated from automated gigapixel optical microscopy [18, 139].

THz-TDS analysis is based on measurements of two time-domain signals, a reference signal recorded under well-known conditions, and a sample signal recorded after interaction with the sample material. The relevant parts of the signals are isolated by temporal windowing and Fourier transformed, giving access to the amplitude and phase of the signals at each frequency point \( \nu \) within the spectral bandwidth. For conductivity characterization and mapping of graphene, measurements can be performed either in reflection or transmission configuration, with similar principles behind the spectroscopic analysis. For brevity, we will describe the transmission configuration here, but state the relevant analytical results for reflection geometry as well.

We consider the situation where the graphene layer is covering a part of the dielectric substrate, as illustrated in figure 10 (inset), a scenario which was first described by Tomaino et al [140]. The THz beam is typically focused to a diffraction-limited spot size, and the sample can be positioned so that the beam either passes through an uncovered section of the substrate (the reference signal), or a section covered by graphene (the sample signal). In the frequency domain (\( \omega = 2\pi\nu \)) and in the plane-wave approximation, the electric fields of the transmitted reference and sample signals are then

\[
\hat{E}_{\text{ref}}(\omega) = \sum_{k=0}^{\infty} E^{(k)}_{\text{ref}}(\omega) = \hat{E}_0(\omega) e^{i\nu_0 t_2} \left( 1 + \sum_{k=1}^{\infty} (t_2 t_{12} e^{i\omega_0})^k \right)
\]

\[
\hat{E}_{\text{sample}}(\omega) = \sum_{k=0}^{\infty} E^{(k)}_{\text{sample}}(\omega) = \hat{E}_0(\omega) e^{i\nu_0 t_2} \left( 1 + \sum_{k=1}^{\infty} (t_2 t_{12} e^{i\omega_0})^k \right)
\]

where \( t_{12}, t_{23}, t_{12n}, t_{23n}, r_{\text{film}}, r_{\text{film}} \) are the Fresnel transmission and reflection coefficients in and out of the uncovered and graphene-covered part of the substrate, respectively, and \( \delta = n_{\text{abs}}\omega d / c \) is the propagation phase through the substrate of thickness \( d \) and refractive index \( n_{\text{abs}} \). The infinite sums describe the multiple internal reflections of the short THz probe pulse in the substrate, as illustrated in figure 10. Here, a THz transient is recorded after transmission through a base substrate (black curve) and a single-layer graphene film on the same substrate (red curve). The direct pass \( E^{(1)}_{\text{ref}} \) as well as three subsequent echoes \( E^{(1,3)}_{\text{film}} \) from the substrate are indicated.

As seen in the figure 10, the characteristic absorption in the graphene film reduces the peak amplitude of the directly transmitted THz field by 15% compared to the reference, which is considerably more than the 2.3% absorption in the visible spectrum [68], see figure 2. The first echo is subject to a larger reduction (47%) of the peak amplitude due to the two interactions with the graphene film (transmission and then reflection). This illustrates that depending on the strength of the interaction between graphene and the THz field, it can be advantageous to use the spectroscopic information contained in the echo signals, as well as in the directly transmitted signal.
In the thin-film limit, \((d \ll \lambda/(2\pi n))\), which almost by definition is perfectly fulfilled for graphene layers, the transmission- and reflection coefficients of the conductive film are

\[
\begin{align*}
\tilde{t}_{\text{film,air}}(\omega) &= \frac{2}{1 + n_{\text{sub}} + Z_0 \tilde{\sigma}(\omega)}, \quad \text{(from air side)} \\
\tilde{t}_{\text{film,sub}}(\omega) &= \frac{2n_{\text{sub}}}{1 + n_{\text{sub}} + Z_0 \tilde{\sigma}(\omega)}, \quad \text{(from substrate side)} \end{align*}
\]

\[
\begin{align*}
\tilde{r}_{\text{film}}(\omega) &= \frac{n_{\text{sub}} - 1 - Z_0 \tilde{\sigma}(\omega)}{n_{\text{sub}} + 1 + Z_0 \tilde{\sigma}(\omega)} \quad \text{(from air side)} \tag{13} \\
\tilde{r}_{\text{film,sub}}(\omega) &= \frac{n_{\text{sub}} - 1 - Z_0 \tilde{\sigma}(\omega)}{n_{\text{sub}} + 1 + Z_0 \tilde{\sigma}(\omega)} \quad \text{(from substrate side)}
\end{align*}
\]

where \(Z_0\) is the free-space impedance, and \(\tilde{\sigma}(\omega)\) is the complex-valued conductivity of the graphene. These expressions are known as the Tinkham relations \[141\].

Combining the relevant terms of the signals from equations (12) and the thin-film coefficients in equations (13) results in expressions that relate the measured transmission functions to the sheet conductance of the graphene, which for the directly transmitted signal and the first echo are, respectively,

\[
\begin{align*}
\frac{E_{\text{R}}^\text{(0)}(\omega)}{E_{\text{R}}^\text{(0)}(\omega)_{\text{sub}}} &= \frac{1 + n_{\text{sub}}}{1 + n_{\text{sub}} + Z_0 \tilde{\sigma}(\omega)} \\
\frac{E_{\text{R}}^\text{(1)}(\omega)}{E_{\text{R}}^\text{(0)}(\omega)_{\text{sub}}} &= \frac{(n_{\text{sub}} + 1)(n_{\text{sub}} - 1 - Z_0 \tilde{\sigma}(\omega))}{(n_{\text{sub}} - 1)(n_{\text{sub}} + 1 + Z_0 \tilde{\sigma}(\omega))^2} \tag{14}
\end{align*}
\]

These relations can be inverted analytically to give expressions that determine the sheet conductance from the measured transmission functions,

\[
\begin{align*}
\tilde{\sigma}_\text{(0)}(\omega) &= \frac{n_{\text{sub}}}{Z_0} \left( \frac{1}{t_{\text{meas}}^\text{(0)}(\omega)} - 1 \right) \\
\tilde{\sigma}_\text{(1)}(\omega) &= \frac{n_{\text{sub}}}{2Z_0 \tilde{t}_{\text{meas}}^\text{(1)}(\omega)} \left( \sqrt{n_{\text{sub}}^2 + 4n_{\text{sub}} n_{\text{sub}}^\text{(1)}(\omega)} - n_{\text{sub}} - 2n_{\text{sub}} \tilde{t}_{\text{meas}}^\text{(1)}(\omega) \right)
\end{align*}
\]

where \(n_{\text{th}} = n_{\text{sub}} + 1\) and \(n_{\text{th}} = n_{\text{sub}} - 1\). The two expressions in equation (15) refer to the same sheet conductance. Experimental noise and systematic errors such as small substrate thickness variations and temporal jitter and drift of the THz-TDS system between sample and reference points may lead to differences in the analytical results from the direct transmission and the first echo. An iterative, variational procedure where both solutions in equation (15) converge to the same solution can strongly suppress such anomalies that may otherwise have significant impact on the apparent conductivity spectrum \[139\], as discussed in section 5.8. In a reflection-style measurement, the reflection ratio of the directly reflected sample- and the reference signals is compared to the theoretical expression, yielding a similar relation for the sheet conductivity,

\[
\tilde{\sigma}_\text{f}(\omega) = \frac{n_{\text{sub}}^2 - 1}{Z_0} \cdot \frac{1 - \tilde{R}_{\text{meas}}(\omega)}{\tilde{R}_{\text{meas}}(\omega)(n_{\text{sub}} - 1) - n_{\text{sub}} - 1}, \tag{16}
\]

with \(\tilde{R}_{\text{meas}}(\omega) = E_{\text{R}}^\text{ref} / E_{\text{R}}^\text{ref}(\omega)\). While reflection-type characterization is not as widely used as transmission-type measurements, it is relevant in situations where the substrate is opaque to the THz signal \[28\], or the geometry of the measurement system prohibits transmission measurements.

### 5.3. Relevant length scales

Several characteristic length scales are relevant for the interpretation of conductivity measurements of graphene with THz spectroscopy. Like any optical beam in free space, the THz beam can be focused to a diffraction-limited spot size \(w_0\) as indicated in figure 11. In contrast to many other spectroscopic techniques, however, it is important to notice that this spot size is not uniquely defined as it is frequency-dependent. The diffraction limited spot size of the THz pulse varies from 3 mm to 0.15 mm in the frequency range 0.1 to 2 THz, with 1 THz corresponding to 0.3 mm.

The graphene film will typically have single-crystalline domains of a characteristic diameter \(L_c\) which is usually significantly smaller than the probe spot size. The statistical variation in crystal orientation associated with CVD growth on most surfaces generally prevents seamless stitching of single grains, leaving lattice imperfections at the grain boundary interfaces \[142\], causing increased electrical resistance \[88\]. The intrinsic length scale probed by THz spectroscopy can be estimated by considering the distance that a carrier moves during the measurement. If the scattering time is shorter than the duration of the THz field (the inverse of its center frequency) then the carriers will on average move a distance given by the electronic diffusion coefficient \(D = E_{\text{R}}(2\nu)^{-1}\) of the material. Thus THz spectroscopy is sensitive to the microscopic conductivity averaged over a length scale \(\ell_0 \sim \sqrt{D}\), corresponding to the characteristic distance traversed by an electron during one cycle of the alternating THz field. Another relevant length scale is the mean free path \(\ell_{\text{mfp}}\). If the carriers are confined to domains comparable to or smaller than \(\ell_{\text{mfp}}\), ballistic confinement effects are expected to influence and dominate the conductivity dynamics, leading to effects such as the Drude–Smith conductivity, see section 2.5.

The characteristic length scale \(\ell_0\) is approximately 30 nm at a frequency of 1 THz, and with typical sample parameters \((\mu = 1000 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}\) and \(n = 10^{12} \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}\) while \(\ell_{\text{mfp}} = 11 \text{ nm}\). Since medium to high-quality graphene has grain boundaries in the micro- to millimeter range, most carriers will not scatter on grain boundaries during a cycle of the electric field for such materials. The conductivity value extracted from a THz spectroscopy measurement at typical frequencies should therefore be an excellent estimator of the average sheet conductivity in an area roughly equal to the spot size, however weighted by the THz field intensity variation across the spot. For sub-micron grain sizes, Drude–Smith like deviations from
the Drude conductivity have to be taken into account to arrive at the correct carrier mobility, as will be discussed further in section 5.6.

5.4. Substrate requirements: thickness variations and THz-transparency

For transmission measurements, the absorption coefficient of the substrate that supports the graphene film should be as low as possible. For quantitative spectroscopic conductivity measurements of graphene films, the complex-valued index of refraction of the substrate must be known across the spectral bandwidth of the measurement, as is apparent from equations (15) and (16). Typically, this information is obtained by a separate THz-TDS measurement on the substrate alone. However, given the lack of an internationally accepted standard protocol for THz-TDS measurements, the substrate characterization should be done independently, and compared with literature values. It is important to note that in the case that the Rayleigh length of the focal region of the THz beam is comparable to the thickness of the substrate, the plane-wave approximation from which the standard THz-TDS algorithms are derived, are not valid. Therefore, substrate characterization should be performed in a geometry where the Rayleigh range is substantially larger than the substrate thickness, or appropriate numerical corrections must be included in the analysis.

Useful substrates for THz-TDS characterization of graphene include undoped silicon, which shows a very low loss ($\alpha < 0.02 \text{ cm}^{-1}$ up to 1.5 THz, $\alpha < 0.05 \text{ cm}^{-1}$ up to 2.7 THz) and negligible dispersion ($n = 3.4175 \pm 0.00005$ in the 0.5–4.5 THz range) [144]. Sapphire, crystalline quartz and fused silica are all usable, but display a somewhat larger absorption coefficient that increases with frequency [145] due to vibrational bands in the mid-THz range. This may prevent practical use as transparent substrate at frequencies above a few THz. Polymeric materials such as poly(methyl methacrylate) (PMMA) display reasonably low absorption across the low THz band, with several vibrational bands at higher frequencies.

Minute thickness variations across the substrate influence the accuracy of the extracted conductivity in a THz-TDS measurement. A thickness variation $\Delta d$ between the sample and reference position on the sample leads to a phase difference $\Delta \phi = \frac{\lambda}{2\sin \theta} \Delta d n_{\text{sub}}$, which influences especially the imaginary part of the extracted conductivity, even for thickness variations of a few tens of nm. However, the linear phase-frequency relation due to thickness uncertainty can be included in the analysis, with $\Delta d$ as an additional fit parameter, thereby significantly improving the reproducibility and quality of the extracted electronic parameters [27, 146]. An extended analysis including multiple substrate echoes (see figure 10) can be used to extract the precise substrate thickness without free parameters. The methodology is extended to take jitter noise (variations in the arrival time of the first THz pulse) into account, which significantly improves the accuracy of carrier density and mobility determination [139], see section 5.8.

Materials that are opaque to THz radiation (such as doped silicon) can also be used as substrate if measurements are performed in a reflection geometry (see equation (16)). In this geometry, knowledge of the substrate optical properties are still needed. In a reflection geometry, the distance between the THz transceiver and the graphene thin film directly influences the time of flight of the THz signal (in contrast to the transmission geometry, where the precise sample position along the focal region is less important). This introduces a timing problem similar to that caused by varying substrate thickness in a transmission geometry.

Figure 11. Schematic illustration of some relevant length scales for conductivity measurements of polycrystalline graphene with THz spectroscopy. $\ell_c$ is a characteristic dimension of the single-crystalline domains of the graphene film, $\ell_D$ is the carrier diffusion length within a cycle of the THz field, $\ell_{\text{mfp}}$ is the mean free path of carriers, and $w_0$ is the diffraction limited spot size of the THz beam.
geometry. However, from a mathematical point of view the two problems are very similar, and can be solved by the same methods.

Finally it should be noted that even without accurate timing information for the transmitted THz signals, the real part of the conductivity can be extracted both in transmission and reflection geometries. Likewise the scattering time and DC conductivity can be obtained from a simplified fitting procedure, although with a lower accuracy than if the full phase information is available. These analysis methods allow THz spectroscopic characterization to be used for inline monitoring in a realistic production environment, even where the precise distance between THz source and detector and the graphene film may be less well controlled than in a laboratory experiment.

5.5. THz-TDS conductivity mapping

With the spectroscopic techniques described in the previous sections, the sheet conductivity of extended areas of graphene can be mapped with a spatial resolution down to a few hundred micrometers, as first demonstrated by Tomaino and colleagues [140]. Here we will discuss a few selected examples of the applicability of the technique with graphene transferred to different substrates (semi-insulating silicon, glass and polymer).

Figure 12(a) shows single-layer graphene sheets on three silicon wafers. The graphene was grown by CVD on a copper foil substrate at 950 °C, 1000 °C and 1050 °C, and transferred to semi-insulating silicon substrates using etching transfer [10]. The THz-TDS spatial map provides a clear overview of the cm-scale uniformity, which improves dramatically as the temperature is increased to 1050 °C. Subsequent doping to increase the electrical conductivity is often needed for transparent electrode applications [11, 81]. To become a competitive alternative transparent electrode material to metal oxides such as ITO, a sheet conductivity larger than at least 10 mS is needed. The conductivity can be increased by using multiple graphene layers, which lowers the optical transmission accordingly. Chemical doping either by substitution of C atoms with dopant atoms such as B or N or by adsorption of molecules from the gas phase [147], metals [66, 148] or organic molecules from solution [149] offers other options for increasing the conductivity. Figure 12(b) shows the sheet conductivity averaged over the 0.8–0.9 THz range for an undoped bilayer graphene sample strip on a glass substrate (1 cm width), and the same sample immediately after adsorption-based doping with gold from a solution of gold chloride (AuCl3).

The sheet conductivity is immediately increased from ~3 to ~8 mS. After 4 weeks, however, the sheet conductivity increase is partly recovered, most probably due to evaporation of the Au dopants during storage under ambient conditions. Figure 12(c) quantifies this effect and compares results for double and triple transferred single-layer graphene sheets. Triple transferred graphene shows a slightly higher sheet conductivity than bilayer graphene, both initially and after adsorption doping. Figure 12(d) compares the increase in sheet conductivity due to AuCl3 doping and HNO3 doping, performed by placing an initially undoped sample over a fuming 65% HNO3 solution for 15 min. Figure 12(e) shows a 15-inch sheet of graphene (along the diagonal), fabricated by Chongqing Institute of Green and Intelligent Technology, Chinese Academy of Science, who develops graphene film technology for cell phone transparent electrodes, currently used for cell phones by Chongqing Graphene Tech Co. Ltd. The spatial maps show that the film appears very uniform, however, the statistical distribution of the conductivity values reveal a clear bimodal distribution, see figure 12(f).

5.6. Microscale uniformity analysis with broadband THz-TDS

Due to the non-resonant nature of the response of unbound charges, the spectral characteristics of the conductivity is extremely broadband. Typical scattering times in graphene range from sub-100 femtosecond (fs) in CVD graphene into the picosecond range for high-quality, single-crystalline graphene. In the Drude model, the characteristic spectral width of the conductivity response is characterized by the criterion \( \omega \tau = 1 \), which defines the crossing point of the real and imaginary part of the conductivity response.

Figures 13(c) and (d) plots the spectral shape of the Drude model, using a charge carrier concentration of \( 5 \cdot 10^{12} \text{cm}^{-2} \) and values for the carrier mobility, \( \mu = 200, 1000, 5000 \text{cm}^2\text{V}^{-1}\text{s}^{-1} \), corresponding to scattering times \( \tau = 5, 26, 130 \text{fs} \), respectively. The main panels show the real part of the sheet conductivity in the 0–5 THz range, and the insets show both real (solid curves) and imaginary (dashed curves) parts of the conductivity in a double-logarithmic plot over a broader spectral range (0.01–100 THz). Figures 13(a) and (b) illustrate schematically the motion of charge carriers in graphene subject to an internal field, for the low (\( \omega \tau < 1 \)) and high (\( \omega \tau > 1 \)) frequency regime, and for large (figure 13(a)) and small (figure 13(b)) grains compared to the THz diffusion length \( \ell_D \) and mean free path \( \ell_{\text{mfp}} \).

In figure 13(a) the conductive domains of the graphene film are larger than the mean free path of the charge carriers (\( \ell_C > \ell_{\text{mfp}} \)), and isotropic scattering dominates—representative of the Drude model. In the low-frequency limit (\( \omega \tau < 1, \ell_C > \ell_D, \ell_{\text{mfp}} \)), carriers scatter several times during an oscillation period of the field, and are subject to a net drift in the external field, leading to an appreciable magnitude of the conductivity. In the high-frequency limit (\( \omega \tau > 1, \ell_C > \ell_D, \ell_{\text{mfp}} \)) the external field changes polarity faster than the scattering rate, and thus charge carriers are accelerated quasi-ballistically with an amplitude \( \propto \omega^{-2} \) along a trajectory still subject to isotropic scattering.

Figure 13(b) shows a situation where the conductive domains are smaller or comparable to the
carrier mean free path ($\ell_C \leq \ell_{mfp}$), representative of the Drude–Smith model ($-1 \leq \varepsilon < 0$). In addition to isotropic impurity scattering, the carriers are subject to scattering at the grain boundaries, leading to a preferred backscattering that hinders the drift of charge carriers over longer distances and consequently leads to a reduction of the conductivity at the lowest frequencies. Figure 13(b) illustrates the low-frequency response for small-grain graphene ($\ell_D > \ell_{mfp} > \ell_C$) where the charge carriers are subject to several scattering events during a cycle of the driving field, but a substantial fraction of the scattering events are backscattering from line-defects (grain boundaries). In the high frequency limit, the influence of the grain sizes diminishes, as can be seen by comparing the ($\omega \tau > 1$) range in the two insets in figures 13(c) and (d).
5.7. Mobility mapping with and without back-gate

Terahertz time-domain spectroscopy offers at least two different approaches to mapping the two key KPIs, $n$ and $\mu$. The conventional approach of using a highly doped silicon substrate to provide the electrical field effect is not ideal, nor is a metallic gate, as the carriers in both types of gates will absorb the majority of the THz-TDS pulse. Instead, the graphene was transferred to a high resistivity silicon wafer ($\rho > 10^4 \text{\Omega cm}$) with a THz-transparent back-gate made from 50 nm highly doped polycrystalline silicon (p-Si) on which a 165 nm silicon nitride (Si₃N₄) dielectric layer was deposited, see figure 14(a). The small-grain crystallinity of the Si layer keeps the carrier mobility very low, $\sim 10^2 \text{cm}^2\text{V}^{-1}\text{s}^{-1}$, despite the high doping level of $n = 2.9 \times 10^{19} \text{cm}^{-2}$, yet still allowing the carrier density in the graphene layer to be fully controlled. Similar to Horng et al [150], the conductivity of the transferred graphene as a function of gate voltage was extracted using the real part of the terahertz conductivity in the frequency range $0.5 - 0.9\text{THz}$, as shown for three different locations in figure 14(b). The hole carrier mobility is evaluated by a linear fit of equation (7) for every negative gate voltage.

---

**Figure 13.** (a) Schematic illustration of charge motion for small backscatter parameter ($c \approx 0$), which is valid for large grain sizes relative to the diffusion length $\ell_D$, and (b) non-zero backscatter parameter ($-1 < c < 0$), corresponding to relatively small grain sizes, and for the low and high frequency regimes, divided by $\omega \tau = 1$. (c) The real and imaginary part of the Drude model compared to the (d) Drude-Smith model for different carrier mobilities $\mu$ and a fixed carrier concentration of $5 \times 10^{12} \text{cm}^{-2}$. For both panels (c) and (d), the insets shows the real and imaginary parts of the conductivity in a double-logarithmic plot. Exemplary sheet conductivity spectra of single-layer graphene grown on (e) sample ‘Cu111’ with a Drude response and (f) sample ‘Cu foil 2’ (polycrystalline Cu foil) with a Drude–Smith response [26] are shown. For the panel (f), the gray lines shows the inability of the Drude model to fit the data.
voltage, and for every position on the sample, see figure 14(c).

The blurry edges of the carrier mobility map occur over a ~1 mm length scale. This is in part due to the finite wavelength of 0.3–0.6 mm in the relevant frequency range which causes the absorbed power to decrease, as more of the beam targets uncovered areas of the surface. As seen by comparing the two panels in figure 14(c), this does not affect the determination of the carrier density; this remains constant all the way to the edge.

The larger variation of the carrier mobility is not just due to this different sensitivity to measurement errors near the edges. In the dashed rectangle in figure 14(c) several millimeters from the edges, the carrier density appears much more uniform than the carrier mobility, which is also clearly seen from the statistical distributions in figure 14(d), from which

$$
\mu = \pm 1174 \, \text{cm}^2 \text{V}^{-1} \text{s}^{-1}
$$

and

$$
\nu = (6.2 \pm 0.3) \times 10^{12} \, \text{cm}^{-2} \text{s}^{-1}
$$

can be determined with a solid statistical basis. This technique involves a deconvolution of the conductivity $$\sigma = n\mu$$ in the individual contributions from $$n$$ and $$\mu$$, allowing precise diagnostics of the essential electrical KPI to be made.

---

Figure 14. Mapping of carrier mobility and carrier density with (a)–(d) and without (e)–(h) an electrostatic gate. (a) Schematic of the sample structure, where a highly doped, low carrier mobility polysilicon layer act as a terahertz-transparent electrostatic gate for tuning the carrier density of the graphene on top of a Si,N,S, dielectric layer. (b) THz-TDS conductivity versus gate voltage in three different spots in the map shown in (c), where both the carrier mobility (left) and carrier density at $$V_g = 0 \, \text{V}$$ (right) are plotted as a function of position. (d) Statistical distribution of $$\mu$$ and $$n$$ derived from the data shown in the dashed rectangle in (c). The carrier mobility is considerably less uniform compared to the carrier density. (e) The electrical field from a terahertz pulse in two points of a 4″ silicon wafer, with and without a single layer of CVD graphene. (f) Fit of the Drude model to the real and imaginary conductivity between 0.25 and 1.25 THz, from which the DC conductivity $$\sigma_{dc}$$ and the scattering time $$\tau$$ can be extracted. (g) Carrier mobility (left) and density (right) mapping. Equations (17) are used to convert the fitting parameters ($$\tau$$, $$\sigma_{dc}$$) to electrical KPI $$s(n, \mu)$$ for every position on the wafer. (h) The statistical distributions of $$\mu$$ and $$n$$, for the area within the dashed rectangle in (g). Adapted from Buron et al [24] and Buron et al [27].
Mobility mapping without a back gate can be achieved by extracting the scattering time from the Drude spectrum to either the real part of the conductivity, \( \sigma_1(\omega) \), or both of the real and imaginary parts, \( (\sigma_1(\omega), \sigma_2(\omega)) \). Taking the phase information into account improves the precision considerably, see section 5.8. Using equations (5) and (6), both the carrier density and mobility are expressed in terms of the fitted DC conductivity \( \sigma_{DC} \) and \( \tau \),

\[
\mu = \frac{e^2 \sigma_{DC}}{\pi \hbar^2} \left( \frac{\pi^2}{\sigma_{DC}} \right),
\]

\[
\mu = \frac{e^2 \sigma_{DC}}{\pi \hbar^2} \left( \frac{\pi^2}{\sigma_{DC}} \right).
\]

The conductivity spectra shown in figures 13(e) and (f), were measured with a custom-built air-plasma ultra-broadband spectrometer, see figure 9(a). In contrast, a commercial spectrometer is far cheaper and easier to operate. The useful spectroscopic bandwidth of up to 1.5 THz for the used spectrometer allows the low frequency tail of the conductivity spectra to be fitted with the Drude (or Drude–Smith) model, as explained in section 5.6, and thus wafer-scale samples to be mapped in less than an hour, depending on the spatial resolution. Since the \( \omega \tau = 1 \) cross-over point moves towards lower frequencies for longer scattering time \( \tau \) (see figure 13(c)), and the signal-to-noise ratio generally improves with higher carrier mobility, the precision of the determination of \( \tau \) and \( \sigma \) during spectral mobility mapping is expected to increase for higher quality graphene substrates.

5.8. Mobility mapping with timing jitter correction

In order to robustly determine electrical properties such as carrier density and mobility from non-gated THz-TDS measurements of graphene (section 5.7) it is beneficial to include both the real and imaginary parts when fitting the frequency dependent conductivity to the Drude model (equation (9), \( \sigma = \sigma_1 + i\sigma_2 \)). Small time shifts (timing jitter and drift) of a few femtoseconds between individual pulses transmitted in a THz-TDS setup can however cause significant variations in the electrical properties extracted from a sample, depending on the choice of reference point on the sample. In order to compensate for timing jitter, one can take advantage of the fact that the extracted sheet conductivity should be the same if it is extracted from the directly transmitted pulse or one of the subsequent echoes arising from internal reflections in the substrate that graphene is transferred to [139].

Figure 15(a) shows an example of the sheet conductivity extracted from both the directly transmitted pulse and the first subsequent echo from one pixel on a sample of graphene transferred to high resistivity (>10 kΩcm) Si. The real parts, \( \sigma_1 \), are roughly in agreement, while the imaginary parts, \( \sigma_2 \), are not, since delays between individual pulses will mainly affect the phase term. This discrepancy between the imaginary
sheet conductivities can be rectified by iteratively multiplying a phase shift $e^{\text{i} \delta}$ to $E_\text{direct}$ in equation (14) until the error between $\sigma(0)$ and $\sigma(1)$ is minimized. Figure 15(b) shows the spectra after a correction corresponding to 4.2 fs, where the imaginary parts now line up, while the real parts have hardly changed at all.

The difference between the mobilities extracted from full fits to both the real and imaginary parts of $\sigma(\omega)$ before and after corrections for 169 pixels on a sample using five different reference points on the substrate is highlighted in figures 15(c) and (d). Before correction there is a significant variation between the different reference points on the samples due to variation in arrival time of the individual pulses from the THz setup at the different reference points. After correction the histograms from the different reference points are on top of each other and the standard deviation is consequently significantly lower. For the calculations of $\tau$ in figure 15(e) the deviations between the values extracted from the directly transmitted pulse and the first echo are much reduced by fitting both $\sigma_1$ and $\sigma_2$ compared to only relying on $\sigma_1$. The same trend is found for $\sigma_4$ and $n$ [139]. This highlights the importance of considering timing jitter between individual pulses when performing THz-TDS measurements, and measuring the imaginary part of the conductivity as well as the real part.

6. Comparison

In the following we compare the three methods which we use to represent fixed contact, movable contact and no-contact electrical characterisation of large-area graphene, namely DLL, M4PP and THz-TDS. Fixed and movable electrodes are by far the most extensively benchmarked and well-established for conventional thin films, while for graphene films both M4PP and THz-TDS may be considered as emerging.

6.1. Measurement accuracy

6.1.1. Spatial correlation

A direct scan across the relatively high quality graphene sample ‘Cu111’ fabricated by growth on single crystal Cu(111) and transferred to silicon dioxide coated silicon substrate by non-destructive electrochemical transfer, allows to directly compare the sheet conductivity measured by M4PP and THz-TDS [26], as shown in figure 16(a). For spatial mapping, one major difference is the effective probe size. The M4PP in the shown case has a pitch of 12 µm, which means that the effective probe size is of the same order [151]. The comparison shows that the conductivity values for $\sigma_{\text{M4PP}}$ are 10–20% higher than $\sigma_{\text{THz}}$ values, and also have a larger statistical spread, which could be due to the higher sensitivity to local variations. The $\sigma_{\text{THz}}$ trace can naively be considered as an averaged version of the $\sigma_{\text{M4PP}}$ trace, however, this assumption is not necessarily valid for non-uniform samples where the overall current flow is disrupted or redirected due to line-defects, tears and ruptures as discussed in section 2.6.

In particular, the conductivity dip around 7.4 mm is much more pronounced in the $\sigma_{\text{M4PP}}$ trace. The conductivity dip coincides with the region of low conductivity indicated by the blue arrow in the $\sigma_{\text{THz}}$ map (figure 15(b)). The slightly lower value of $\sigma_{\text{THz}}$ compared to $\sigma_{\text{M4PP}}$ is due to the THz conductivity being taken as the value of $\sigma_1$ at 0.9–1.0 THz, where its value has rolled off slightly compared to the corresponding DC value. This is clear from the conductivity spectrum in figure 14(f).

6.1.2. Statistical correlation and uniformity: THz-TDS compared to M4PP

We investigated the correlation between the THz-TDS and the M4PP conductivity for the sample analysed in figure 6, as well as two other samples of higher quality [26]. Figure 17(a) shows a direct comparison of the two conductivity maps for three different samples: ‘Cu foil 1’, which is CVD graphene grown on commercial copper foil, and transferred by Etching transfer. The sample was selected on its clear, optically visible, macroscopic damage. In contrast, ‘Cu foil 2’, was grown on commercial Cu foil and transferred by oxidative decoupling transfer (ODT) [18], while ‘Cu111’, was grown by same recipe as ‘Cu foil 2’, but...
on single crystalline Cu(111), and transferred by ODT. In the graph, the full line indicates 1:1 correlation, while the upper and lower dashed lines mark regions with up to 10% deviation from perfect correlation.

For the sample ‘Cu foil 1’, the correlation is roughly clustered around 1:1, but with a large spread towards lower $\sigma_{M4PP}$ values. This can be understood from the lack of uniformity as described earlier in section 4.3. The panels in figure 17(b) show the uniformity parameter for the three samples, which for four point probes should give $\beta_{AB} = R_A/R_B = 1.26$ in the case of perfect uniformity. Instead, the uniformity analysis shows that ‘Cu foil 1’ exhibits a large number of line-shaped defects, which results in lower values of the measured conductivity, and a clustering of values around $\beta_{AB} = 1$. ‘Cu foil 1’ shows the characteristic bimodal distribution, indicating that part of the measured areas exhibit 1D-like current flow, as discussed in sections 4.2 and 4.3, as apparent by comparing with the Monte Carlo simulated distribution of $\mu_{AB}$ in figure 7(b).

The sample ‘Cu foil 2’ shows uniformity in much better agreement with $\beta_{AB} = 1.26$ while the sample grown on copper single crystal, ‘Cu111’, is in excellent agreement with the Monte Carlo simulated distribution for a uniform sample (full lines in figure 17(b)). The correlation plot (a) shows the same tendency: ‘Cu foil 2’ shows mostly correlated THz versus M4PP conductivity, while nearly all points on sample ‘Cu111’ are within 10% of the 1:1 correlation line. These observations are in line with our earlier statement that for samples with a low level of line-defects, the electrical contact and THz conductivity converge, as the device sheet conductance measured by electrical probes approach the average, intrinsic sheet conductivity measured by the THz-method. This is discussed in some detail in sections 2.3 (DC conductivity of graphene) and 5.3 (relevant length scales). The $\sigma_{THz}$ is thus relatively insensitive to microscale current discontinuities, which explains the much smaller sensitivity to structural damage compared to $\sigma_{M4PP}$.

6.1.3. Statistical correlation and uniformity: THz-TDS compared to vdP measurements

Figure 18(a) shows the DC conductivity measured by THz-TDS of a 4″ graphene sheet on a silicon wafer. The wafer is then patterned using stencil mask/laser ablation lithography (DLL), and mapped once more with THz-TDS. From this it is evident that the conductivity changes very little by the processing. This is also shown in the inset of figure 18(b), where the statistical distributions before and after fabrication show only little difference, which is easily accounted for by the fact that the graphene conductivity is susceptible to humidity and that the THz-TDS measurements are affected by absorption in the metal electrodes, which is further discussed in [152]. This low impact of the processing is unsurprising, as the DLL method avoids physical contact with solvents and water. Figures 18(d) and (e) shows the correlation between THz-TDS and vdP measurements for the conductivity, carrier mobility and carrier density. In all three cases, the colored points correspond to measurements with a high degree of uniformity, represented by $0.9 < \beta_{AC} < 1.1$, and using dual configuration vdP as indicated in figure 3(h). The grey points are from less
uniform areas. For the points recorded in electrically uniform areas, the correlation is generally good, with a few outliers compared to the shaded regions (in (e) and (f)), which represent correlation between 1:2 and 2:1.

### 6.2. Throughput and upscaling opportunities

#### 6.2.1. Dry laser lithography

With the used laser micromachining and dry shadow mask technique termed DLL—dry laser lithography, the total time including setup and writing for patterning one wafer, as well as metal deposition, is about an hour. However, the increase in time expected for making a larger number of smaller devices will be comparably small; the fraction of the total time spent on ablation of the 49 devices is of order 1 min, since the devices can be defined by ablating narrow lines. Entire removal of continuous areas is not necessary to produce working devices, so in principle thousands of devices can be defined in a few minutes. The electrical testing could be done in few minutes to hours with an automated probe station, depending on whether gate sweeps are needed at each point to compute $n$ and $\mu$. This makes it in principle possible to reduce the total turn-around time excluding graphene transfer to 1 h in total for creating a spatial map with hundreds of van der Pauw devices of mm$^2$–cm$^2$ dimensions. With this, mapping of electrical KPI could be competitive with non-contact measurement methods in terms of cleanliness and throughput, while still requiring irreversible processing of the sample wafer.

#### 6.2.2. Micro four point probes

The scanning micro four point probe is already a well-established, mature technology, developed for thin film and surface characterisation mainly in the semiconductor industry. Commercial M4PP mapping systems as well as dedicated probes are available, and have been shown to provide accurate information on sheet conductance and other key performance indicators on CVD graphene films. The technology is scalable per se, but adaptations of the systems may be necessary to accommodate the special boundary conditions of graphene thin films on silicon and in particular on non-smooth substrates such as polymers. Despite the development of special probes that minimize contact pressure and reduce the risk of the probes scratching the graphene film [153], the probes still make physical contact to the film, and may leave contact metal residues in small amounts behind on the surface. The physical contact also makes strict requirements on the flatness of the substrate and on the absence of warping. While this is not necessarily a problem in relation to graphene on silicon wafers, inline characterisation of graphene transferred to polymer foil may be difficult, as the requirements of surface flatness for consistent physical contact between probe and surface may be considerably harder to obtain. The M4PP technique is highly relevant for benchmarking, as it provides the only existing high-resolution, direct mapping of thin film conductance proven to be working with graphene. However,
for many quality control and process development scenarios in inline production as well as R&D, non-contact methods with higher throughput and smaller restrictions on the substrate are relevant to consider.

6.2.3. THz-TDS systems

The systems discussed here serve to demonstrate the possibilities and to study the relationship between the THz-response and the conducting properties of CVD graphene, and are not designed for high throughput performance. It is relatively straightforward to increase the speed of the mechanical stage and the spectrometer, which would result in 1–2 orders of magnitude increase of throughput even when considering only off-the-shelf optical and mechanical components. The limiting factor would then be the power of the laser, the scanning speed of the mechanical stage, and the signal-to-noise ratio as well as the sample rate of the spectrometer. Using components available today, and optimizing for throughput, a 4" silicon wafer could be imaged with 1 mm resolution (7800 points) in about a minute, assuming a time of 10 ms per spectrum. While basic data treatment (i.e. mapping of DC conductivity) can be performed in real time, advanced analysis to extract \( n \) and \( \mu \), and maybe even with advanced error-reducing measures such as described in section 5.8, will be more computationally demanding. This process could be pushed towards real-time operation for instance by employing graphical processing units (GPU) assisted systems, and by optimization of the calculation and fitting algorithms. Advanced full-frame imaging modalities such as time-resolved line or full-frame imaging arrays are other attractive possibilities for fast, high-resolution mapping at speeds required for inline monitoring.

The image resolution is a weakness of the THz-TDS technique. The resolution of the KPI maps is limited by the diffraction limited spot size of the THz beam, which is 0.3 mm for 1 THz. Recent developments in near-field THz probes \([154, 155]\) pushes the obtainable resolution to a few \( \mu \)m, at the cost of longer acquisition time or smaller scan area, due to the serial data acquisition.

For integration with a roll-to-roll production setup, a continuous THz-TDS line scan is possible to integrate, after the graphene has been transferred to terahertz-transparent material, such as a polymer substrate. One of the most important advantages of THz-TDS is that it does not involve physical contact with the surface of the sample and it is a non-destructive measurement. It is foreseeable, that also for graphene films, the requirements of cleanliness will continue to become even more strict, as the production is professionalized and the demands of consistency, reproducibility and quality increase further. For many emerging semiconductor based material technologies, including magnetic tunnel junctions \([156]\) and ultra-shallow junctions \([83]\), physical contact with the surface is unacceptable. Another exciting possibility is to measure the properties of passivated graphene, i.e. which has been covered by a top layer, either to protect it against chemical or physical influences from the environment \([64]\), or to promote ultra-high electrical performance \([94]\). All in all, THz-TDS is excellently suited for upscaling towards inline quality control, and appears to be fully compatible with roll-to-roll production lines.

7. Summary

We argue here that systematic, accurate and high-throughput approaches towards spatial mapping of the electrical properties of graphene is a long-overdue requirement for development of truly competitive, graphene-based technologies. With that scope, we have provided an overview of our research efforts in developing suitably optimized methods to address this problem in three different classes: fixed contacts, movable contacts and non-contact. We pay particular attention to the importance of uniformity analysis on different length scales, and show how the dual configuration electrical measurement provides a simple yet powerful insight into the properties of individual and small collections of samples. In providing large-area spatial maps of the electrical key performance indicators, terahertz time-domain spectroscopy is second-to-none in some sense more accurate than electrical measurements, with excellent possibilities for pushing the already impressive throughput to even higher levels, and with striking opportunities for analyzing the grain structure of polycrystalline graphene films through inspection of the frequency dependent conductivity spectrum. As we intended this article to be as useful as possible for the reader, and since there is a distinct lack of comprehensive reviews on this absolutely crucial topic, we have provided some details on the methodologies. Perhaps the most intriguing perspective of the terahertz time-domain spectroscopy is that it provides contact-less, yet accurate, information on the conducting properties of any conducting thin film. Among the 2D materials, semiconducting materials are notoriously difficult to contact electrically, and we anticipate that THz-TDS may in the future not just provide the best and fastest, but also only possible means of measuring the intrinsic properties of semiconducting 2D materials, as well as encapsulated and passivated materials on large scales, to the benefit of research, development and production alike.

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